## Part Numbering

## CERALOCK® (MHz)

(Global Part Number) CS T CV 16M0 X53 \*\*\* -R0

### Product ID

Product ID	
cs	Ceramic Resonators

## 2Frequency/Capacitance

Code	Frequency/Capacitance
Α	MHz No capacitance built-in
Т	MHz Built-in Capacitance

#### 3Structure/Size

Code	Structure/Size
LA	Lead Type
LS	Round Lead Type
СС	Cap Chip Type
CR/CE/CG	Small-cap Chip Type
CV	Monolithic Chip Type
CW	Small Monolithic Chip Type

### **4** Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (MHz). Decimal point is expressed by capital letter "**M**".

## 6 Design

Code	Design
G□□	Thickness Shear mode
T/V□□	Thickness Expander mode
	Thickness Expander mode (3rd overtone)

□□ indicates initial frequency tolerance and load capacity.

## CERALOCK® (kHz)

## Product ID

Product ID	
cs	Ceramic Resonators

## 2 Frequency/Capacitance

Code	Frequency/Capacitance
В	kHz No capacitance built-in

#### 3Structure/Size

Code	Structure/Size
LA	Two-Terminal Lead Type
FB	SMD Type

## **4** Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz). Capital letter "**K**" following three figures expresses the unit of "kHz".

## 6 Individual Specification

Code	Individual Specification
***	Three-digit alphanumerics express "Individual Specification".

With standard products, "Individual Specification" is omitted, and "Package Specification Code" is carried up.

### Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H <sub>0</sub> =18mm
-A1	Radial Taping H <sub>0</sub> =16mm
-R0	Plastic Taping ø=180mm
-R1	Plastic Taping ø=330mm

Radial taping is applied to lead type and plastic taping to chip type.

## 6 Design

Code	Design
E	Area Expansion mode
J	Area Expansion mode (Closed Type)

□□ indicates initial frequency tolerance and load capacitance.

## 6 Individual Specification

Code	Individual Specification
***	Three-digit alphanumerics express "Individual Specification".
With standard prod	lucts, "6Individual Specification" is omitted, and

With standard products, "6Individual Specification" is omitted, and "Package Specification Code" is carried up.

## Packaging

Code	Packaging
-B0	Bulk
-R1	Plastic Taping ø=330mm



# Ceramic Resonators (CERALOCK®)



## Chip Type Three-Terminals CSTCC/E/G/R/V/W Series

Chip "CERALOCK" with built-in load capacitance in an extremely small package.

MURATA's package technology expertise has enabled the development of the Chip "CERALOCK" with built-in load capacitors.

High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

## ■ Features

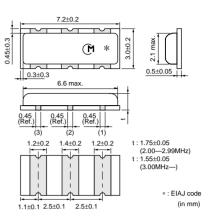
- 1. Oscillation circuits do not require external load capacitors.
- 2. The series is available in a wide frequency range.
- 3. The resonators are extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

## ■ Applications

- · Clock oscillators for microprocessors.
- Electronic control circuits for small electronic equipment such as hand held movie.
- Audio-visual applications (Camcorder, Remote Controller, etc.)
- Office automation equipments (DVD, CD-ROM, HDD, FDD, etc.)
- Automotive electronics. (CSTCC\_G\_A series, CSTCR\_G\_A series, CSTCE G A series, CSTCV X Q series)
- Dual Tone Multi Frequency (DTMF) generator for cordless telephones.

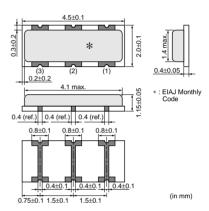


CSTCC\_G(\_A) 2.00-3.99MHz



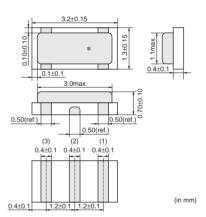


CSTCR G(A) 4.00-7.99MHz



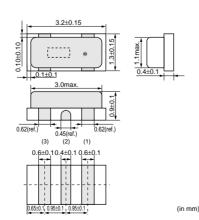


CSTCE\_G(\_A) 8.00-12.50MHz



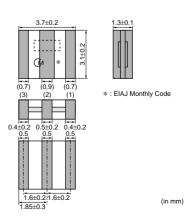


CSTCF V 12.51-19.99MHz





CSTCV X O 14.70-70.00MHz



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